HLMP-Cx08 Series, HLMP-Cx25 Series HLMP-Cx27 Series, HLMP-C610

T-1³/₄ (5 mm) AllnGaP Lamps

Data Sheet





Description

The HLMP-Cx08, HLMP-Cx25, HLMP-Cx27, and HLMP-C610 series are 5 mm lamps specially designed for applications requir-ing very high on-axis intensity that is not achievable with a standard lamp. These devices are capable of producing light output over a wide range of drive currents.

Built using AllnGaP technology, they are well suited for typical 5 mm TS-AlGaAs lamp applications, and have significantly SUPERIOR RELIABILITY than most TS-AlGaAs lamps in wet/hot environments. These lamps come with clear non-diffused lens and are optically designed to yield superior light output.

Features

- High intensity
- General purpose leads
- Popular 5 mm diameter
- Available in bulk, tape and reel, or ammopack
- 8° or 25° viewing angles
- Choice of colors: Amber or Red

Applications

- Indoor/outdoor applications
- Small store-front signs
- Message panels
- Road construction barrier lights
- Center high mount stop lights
- Spoiler, car decorative lighting
- Motorcycle/bicycle warning lights

Device Selection

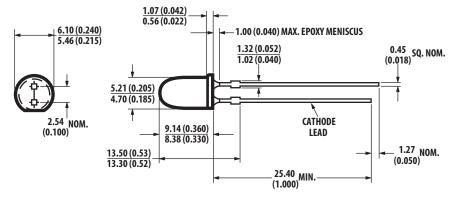
		Typical Viewing Angle ^[1] (degrees),	Luminous Intensity, lv (mcd) @ 20 mA			Dominant
Part Number	Standoff	2θ _{1/2}	Min.	Тур.	Color	Wavelength ^[2]
HLMP-C008-U00xx	No	8	2900	6000	Red	626
HLMP-C208-S00xx		8	2600	3000	Amber	590
HLMP-C608-R00xx		8	1000	2000	Red	635
HLMP-C610-R00xx	Yes	8	1000	2000	Red	635
HLMP-C025-P00xx	No	25	500	1000	Red	626
HLMP-C225-O00xx		25	450	800	Amber	590
HLMP-C625-P00xx		25	500	700	Red	635
HLMP-C027-P00xx	Yes	25	500	1000	Red	626
HLMP-C627-P00xx		25	500	700	Red	635
HLMP-C325-P00xx	No	25	500		Orange	605

Notes

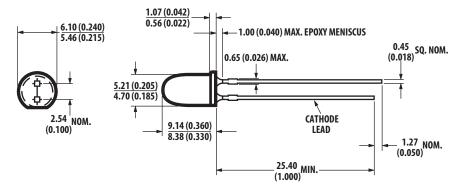
- 1. $\theta^{1/2}$ is the off-axis angle at which the luminous intensity is half of the axial luminous intensity.
- 2. The dominant wavelength, λ_d , is derived from the CIE chromaticity diagram and represents the single wavelength that defines the color of the device.

Package Dimensions

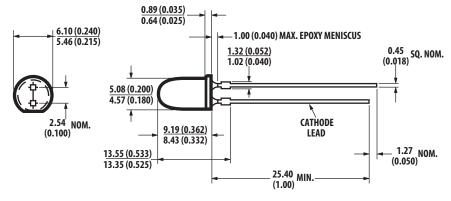
HLMP-Cx27



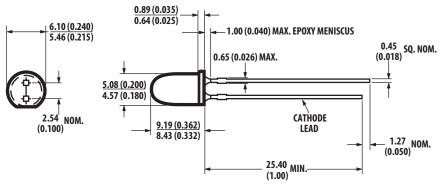
HLMP-Cx25



HLMP-C610



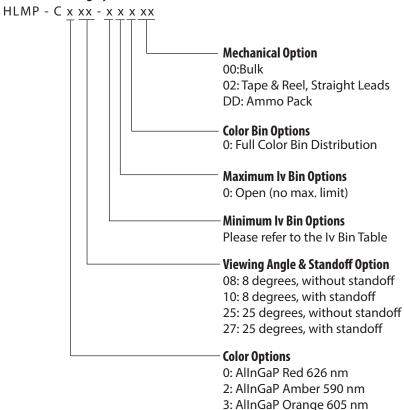
HLMP-Cx08



Notes:

- 1. All dimension are in mm (inches).
- 2. For PCB hole recommendations, see the Precautions section.

Part Numbering System



Absolute Maximum Ratings at T_A = 25 °C

Parameter	Absolute Maximum	Units	
Peak Forward Current	70	mA	
Average Forward Current ^[1]	30	mA	
DC Current ^[2]	50	mA	
Reverse Voltage ($I_R = 100 \mu A$)	5	V	
LED Junction Temperature	110	°C	
Operating Temperature Range	-40 to +100	°C	
Storage Temperature Range	-40 to +100	°C	

6: AlInGaP Red 635 nm

Notes:

- 1. See Figure 2 to establish pulsed operating conditions.
- 2. Derate linearly from 50 °C at 0.5 mA/°C.
- 3. The transient peak current is the maximum non-recurring peak current that can be applied to the device without damaging the LED die and wirebond. It is not recommended to operate this device at peak currents above the Absolute Maximum Peak Forward Current.

Optical/Electrical Characteristics at T_A=25°C

Symbol	Parameter	Device	Min.	Typ.[3]	Max.	Units	Test Conditions
$2\theta^{1}/_{2}$	Included Angle Between Half	HLMP-C008		8		Deg.	$I_F = 20 \text{ mA}$
	Luminous Intensity Points ^[1]	HLMP-C208		8			See Note 1
		HLMP-C608		8			
		HLMP-C025		25			
		HLMP-C225		25			
		HLMP-C325		25			
		HLMP-C625		25			
		HLMP-C610		8			
		HLMP-C027		25			
		HLMP-C627		25			
λd	Dominant Wavelength ^[2]	HLMP-C008		626		nm	See Note 2
		HLMP-C208		590			
		HLMP-C608		635			
		HLMP-C025		626			
		HLMP-C225		590			
		HLMP-C325		605			
		HLMP-C625		635			
		HLMP-C610		635			
		HLMP-C027 HLMP-C627		626 635			
λ ΡΕΑΚ	Peak Wavelength	HLMP-C008		635		nm	Measurement at Peak
		HLMP-C208		594			
		HLMP-C608		650			
		HLMP-C025		635			
		HLMP-C225		594			
		HLMP-C325 HLMP-C625		611 650			
		HLMP-C610		650			
		HLMP-C010		635			
		HLMP-C627		650			
$\Delta \lambda^{1}/_{2}$	Spectral Line Halfwidth			17		nm	
τ ς	Speed of Response			20		ns	
C	Capacitance			40		рF	V _F = 0; f = 1 MHz
Rθ _{J-PIN}	Thermal Resistance			260		°C/W	Junction to Cathode Lead
V _F	Forward Voltage	HLMP-C008		1.9	2.4	V	I _F = 20 mA
	•	HLMP-C208		1.9	2.6		
		HLMP-C608		1.9	2.2		
		HLMP-C025		1.9	2.4		
		HLMP-C225		1.9	2.6		
		HLMP-C625		1.9	2.2		
		LILAD CC10		1.9	2.2		
		HLMP-C610					
		HLMP-C027		1.9	2.4		

- 1. $\theta^{1/2}$ is the off-axis angle at which the luminous intensity is half of the axial luminous intensity.

 2. The dominant wavelength, λ_d , is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the
- 3. Typical specification for reference only. Do not exceed absolute maximum ratings.

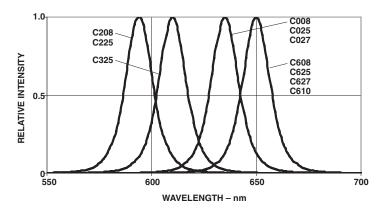


Figure 1. Relative intensity vs. wavelength.

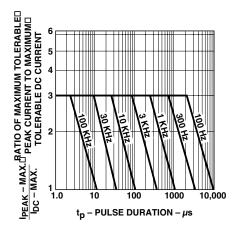


Figure 2. Maximum tolerable peak current vs. pulse duration.

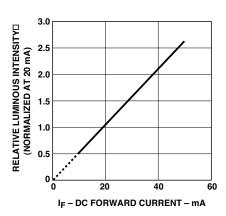


Figure 4. Relative luminous intensity vs. forward current.

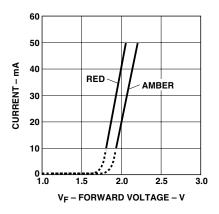


Figure 3. Forward current vs. forward voltage.

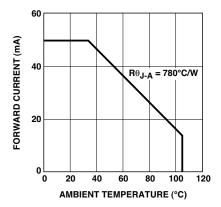


Figure 5. Maximum forward DC current vs. ambient temperature.

Soldering/Cleaning

Cleaning agents from the ketone family (acetone, methyl ethyl ketone, etc.) and from the chlorinated hydrocarbon family (methylene chloride, trichloro-ethylene, carbon tetrachloride, etc.) are not recommended for cleaning LED parts. All of these various solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

For information on soldering LEDs, please refer to Application Note 1027.

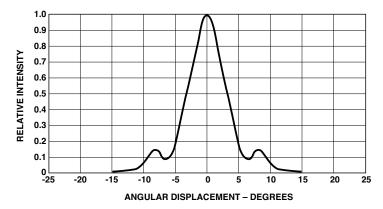


Figure 6. Relative luminous intensity vs. angular displacement for HLMP-Cx08 and HLMP-Cx10.

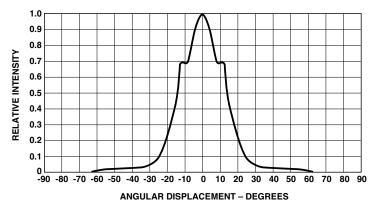


Figure 7. Relative luminous intensity vs. angular displacement for HLMP-Cx25 and HLMP-Cx27.

Intensity Bin Limits

		Intensity Range (mcd)			
Color	Bin	Min.	Max.		
Res/Orange	Р	540.0	850.0		
	Q	850.0	1200.0		
	R	1200.0	1700.0		
	S	1700.0	2400.0		
	Т	2400.0	3400.0		
	U	3400.0	4900.0		
	V	4900.0	7100.0		
	W	7100.0	10200.0		
	X	10200.0	14800.0		
	Υ	14800.0	21400.0		
	Z	21400.0	30900.0		
Yellow	0	510.0	800.0		
	Р	800.0	1250.0		
	Q	1250.0	1800.0		
	R	1800.0	2900.0		
	S	2900.0	4700.0		
	Т	4700.0	7200.0		
	U	7200.0	11700.0		
	V	11700.0	18000.0		
	W	18000.0	27000.0		

Color Categories

	Lambda (nm)	
Category#	Min.	Max.
2	599	602.5
3	601.5	605
4	603.8	608.2
5	606.8	611.2
	2 3 4	2 599 3 601.5 4 603.8

Tolerance for each bin limit is ± 0.5 nm.

Maximum tolerance for each bin limit is $\pm 18\%$.

Mechanical Option Matrix

Mechanical Option Code	Definition	
00	Bulk Packaging, minimum increment 500 pcs/bag	
02	Tape & Reel, straight leads, minimum increment 1300 pcs/bag	
DD	Ammo Pack, straight leads with minimum increment 2K/pack	

Note

All categories are established for classification of products. Products may not be available in all categories. Please contact your local Avago representative for further clarification/information.

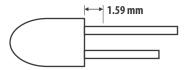
Precautions:

Lead Forming:

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering on PC board.
- For better control, it is recommended to use proper tool to precisely form and cut the leads to applicable length rather than doing it manually.
- If manual lead cutting is necessary, cut the leads after the soldering process. The solder connection forms a mechanical ground which prevents mechanical stress due to lead cutting from traveling into LED package. This is highly recommended for hand solder operation, as the excess lead length also acts as small heat sink.

Soldering and Handling:

- Care must be taken during PCB assembly and soldering process to prevent damage to the LED component.
- LED component may be effectively hand soldered to PCB. However, it is only recommended under unavoidable circumstances such as rework. The closest manual soldering distance of the soldering heat source (soldering iron's tip) to the body is 1.59mm. Soldering the LED using soldering iron tip closer than 1.59mm might damage the LED.



- ESD precaution must be properly applied on the soldering station and by personnel to prevent ESD damage to the LED component that is ESD sensitive. For details, refer to Avago application note AN 1142. The soldering iron used should have a grounded tip to ensure electrostatic charge is properly grounded.
- Recommended soldering conditions:

	Wave Soldering ^{[1],[2]}	Manual Solder Dipping
Pre-heat Temperature	105°C Max.	-
Pre-heat Time	60 sec Max.	_
Peak Temperature	250°C Max.	260°C Max.
Dwell Time	3 sec Max.	5 sec Max.
Notos		

Notes:

- These conditions refer to measurement with a thermocouple mounted at the bottom of the PCB.
- To reduce thermal stress experienced by the LED, it is recommended that you use only bottom preheaters.

 Wave soldering parameters must be set and maintained according to the recommended temperature and dwell time. Customer is advised to perform daily check on the soldering profile to ensure that it is always conforming to recommended soldering conditions.

Note:

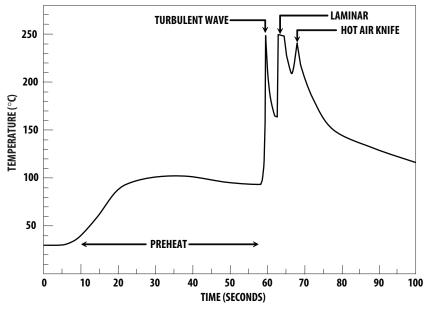
- PCB with different size and design (component density) will have different heat mass (heat capacity). This might cause a change in temperature experienced by the board if same wave soldering setting is used. So, it is recommended to re-calibrate the soldering profile again before loading a new type of PCB.
- Customer is advised to take extra precaution during wave soldering to ensure that the maximum wave temperature does not exceed 250°C and the solder contact time does not exceeding 3sec. Over-stressing the LED during soldering process might cause premature failure to the LED due to delamination.
- Any alignment fixture that is being applied during wave soldering should be loosely fitted and should not apply weight or force on LED. Non metal material is recommended as it will absorb less heat during wave soldering process.
- At elevated temperature, LED is more susceptible to mechanical stress. Therefore, PCB must allowed to cool down to room temperature prior to handling, which includes removal of alignment fixture or pallet.
- If PCB board contains both through hole (TH) LED and other surface mount components, it is recommended that surface mount components be soldered on the top side of the PCB. If surface mount need to be on the bottom side, these components should be soldered using reflow soldering prior to insertion the TH LED.
- Recommended PC board plated through holes (PTH) size for LED component leads:

	LED Component Lead Size	Diagonal	Plated Through- Hole Diameter
Lead size (typ.)	0.45 × 0.45 mm	0.636 mm	0.98 to 1.08 mm
	(0.018 × 0.018 in.)	(0.025 in)	(0.039 to 0.043 in)
Dambar shear-	0.65 mm	0.919 mm	_
off area (max.)	(0.026 in)	(0.036 in)	
Lead size (typ.)	0.50 × 0.50 mm	0.707 mm	1.05 to 1.15 mm
	(0.020 × 0.020 in.)	(0.028 in)	(0.041 to 0.045 in)
Dambar shear-	0.70 mm	0.99 mm	_
off area (max.)	(0.028 in)	(0.039 in)	

 Over-sizing the PTH can lead to a twisted LED after it is clinched. On the other hand, undersizing the PTH can make inserting the TH LED difficult.

For more information about soldering and handling of TH LED lamps, refer to application note AN5334.

Example of Wave Soldering Temperature Profile for TH LED



Recommended solder: Sn63 (Leaded solder alloy) SAC305 (Lead-free solder alloy)

Flux: Rosin flux

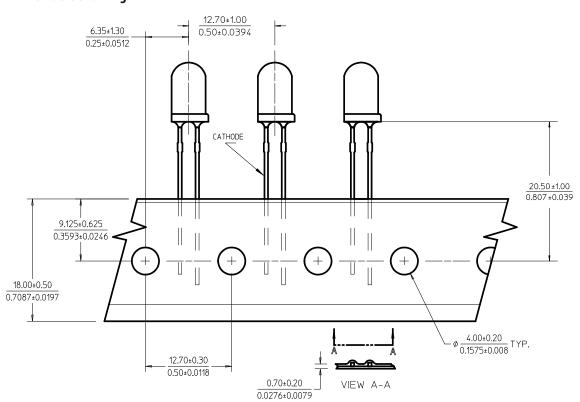
Solder bath temperature:

245 °C± 5 °C (maximum peak temperature = 250 °C)

Dwell time: 1.5 sec - 3.0 sec (maximum = 3 sec)

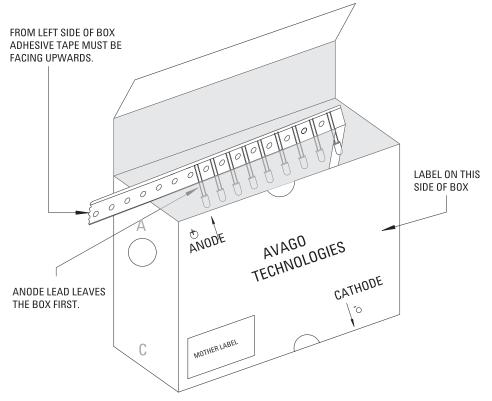
Note: Allow for board to be sufficiently cooled to room temperature before exerting mechanical force.

Ammo Packs Drawing



Note: Dimension in mm(inches).

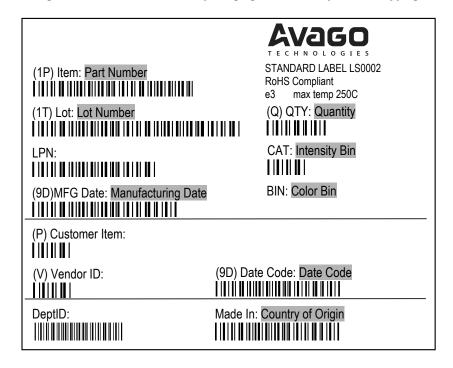
Packaging Box for Ammo Packs



Note: The dimension for ammo pack is applicable for the device with standoff and without standoff.

Packaging Label:

(i) Avago Mother Label: (Available on packaging box of ammo pack and shipping box)



(ii) Avago Baby Label (Only available on bulk packaging)

AVAGO TECHNOLOGIES Lamps Baby Label	RoHS Compliant e3 max temp 250C		
(1P) PART #: Part Number			
(1T) LOT #: Lot Number			
(9D)MFG DATE: Manufacturing Date	QUANTITY: Packing Quantity		
C/O: Country of Origin			
Customer P/N:	CAT: Intensity Bin		
Supplier Code:	BIN: Color Bin		
	DATECODE: Date Code		

For product information and a complete list of distributors, please go to our web site: **www.avagotech.com**



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard LEDs - Through Hole category:

Click to view products by Broadcom manufacturer:

Other Similar products are found below:

LTL-10254W LTL-1214A LTL-1BEDJ LTL-2231AT LTL-3251A LTL-4262N LTL-5234 LTL87HTBK LTW-87HD4B 7383/V7C3-BSTA-L/PR3/MS HLMP-AG64-X10ZZ HLMP-EG1A-Z10DV HLMP-EL3B-WXKDD HLMP-HB74-UVBDD HLMP-HG65-VY0DD HLMP-HM74-34CDD HLMP-HM75-34CDD 1L0532V23G0TD001 NSPW500CS C4SMA-BGF-CQ34Q3C2 L53GC13 264-7SURTS530-A3 L-C150JRCT S4SMS-BJF-CQ42QGF2 S4SMS-GJF-CW12QMF2 LD CQDP-1U3U-W5-1-K LO566UHR3-70G-A3 SLA560WBD2PT3 LP379PPG1C0G0300001 SLR-322MCT32 SLR-342DUT32 SLR-342MC3F SLR343BC7TT32 SLR343BCTT32 SLX-LX3044GD SLX-LX3044ID SLX-LX3044YD 1.90690.3330000 SSL-LX20483ID SSL-LX3034YD SSL-LX5093LGT-11 SSL-LX5093PGC SSL-LX5093SRC/F SSL-LX5093SYT SSL-LX509E3SIT SSL-LX509FT3ID SSL-LX50FT3GD SSS-LX4673ID-410B 1L0532Y24I0TD001 264-7SYGD/S530-E2